



Features

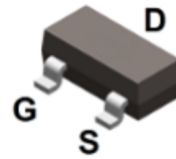
- Advanced trench technology
- High-speed switching
- Drive circuits can be simple
- Parallel use is easy

Typical Applications

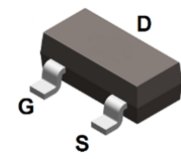
- P-channel enhancement mode effect transistor
- Switching application

Mechanical Data

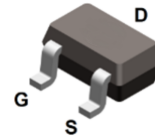
- Case: SOT-23, SOT-23-3L, SOT-323
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte tin-plated leads; solderability-per MIL-STD-202, Method 208



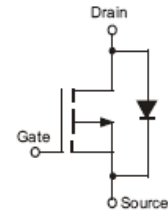
BSS84
SOT-23



BSS84-3L
SOT-23-3L



BSS84W
SOT-323



Ordering Information

Part Number	Package	Shipping Quantity	Marking Code
BSS84	SOT-23	3000 pcs / Tape & Reel	SP
BSS84-3L	SOT-23-3L	3000 pcs / Tape & Reel	SP
BSS84W	SOT-323	3000 pcs / Tape & Reel	K84

Maximum Ratings (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	V_{DSS}	-50	V
Gate-to-Source Voltage	V_{GSS}	± 12	V
Continuous Drain Current ($T_A = 25^\circ\text{C}$) *1	I_D	-130	mA
Pulsed Drain Current ($t_p = 10\mu\text{s}$, $T_A = 25^\circ\text{C}$)	I_{DM}	-520	mA
Single Pulse Avalanche Energy *3	E_{AS}	0.4	mJ
Power Dissipation ($T_A = 25^\circ\text{C}$) *1	SOT-23	0.36	W
	SOT-23-3L	0.36	
	SOT-323	0.2	
Operating Junction Temperature Range	T_J	-55 ~ +150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 ~ +150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance Junction-to-Air *1	SOT-23, SOT-23-3L	350	$^\circ\text{C/W}$
	SOT-323	625	



Electrical Characteristics (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
V_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = -250\mu A$	-50	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -50V, V_{GS} = 0V$	-	-	-1	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	± 10	μA
On Characteristics						
$R_{DS(ON)}$	Drain-Source On-resistance ^{*2}	$V_{GS} = -5V, I_D = -0.1A$	-	2.1	10	Ω
$V_{GS(TH)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -1mA$	-0.8	-1.5	-2	V
R_G	Gate Resistance	$V_{GS} = 0V, f = 1MHz$	-	84	-	Ω
Dynamic Characteristics						
C_{ISS}	Input Capacitance	$V_{GS} = 0V$	-	48	-	pF
C_{OSS}	Output Capacitance	$V_{DS} = -20V$	-	15	-	
C_{RSS}	Reverse Transfer Capacitance	$f = 1.0MHz$	-	3	-	
Switching Characteristics						
$t_{d(on)}$	Turn-on Delay Time ^{*4}	$V_{DD} = 30V, I_D = 0.2A$ $V_{GS} = 10V, R_G = 25\Omega$ $R_L = 150\Omega$	-	6	-	nS
t_r	Turn-on Rise Time ^{*4}		-	5	-	
$t_{d(off)}$	Turn-Off Delay Time ^{*4}		-	25	-	
t_f	Turn-Off Fall Time ^{*4}		-	15	-	
Q_G	Total Gate-Charge	$V_{DD} = -30V$	-	2.1	-	nC
Q_{GS}	Gate to Source Charge	$V_{GS} = -4.5V$	-	0.78	-	
Q_{GD}	Gate to Drain (Miller) Charge	$I_D = -0.2A$	-	0.4	-	
Source-Drain Diode Characteristics						
V_{SD}	Diode Forward Voltage ^{*2}	$I_S = -0.26A, V_{GS} = 0V$	-	-1.15	-1.4	V

Notes:

- 1、 Surface mounted on FR4 board, and standard footprint, $t \leq 10$ sec
- 2、 The data tested by pulsed, pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
- 3、 The E_{AS} data shows Max. rating. The test condition is $V_{DD} = -30V, V_{GS} = -10V, L = 0.1mH$
- 4、 Guaranteed by design, not subject to production



Ratings and Characteristics Curves (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

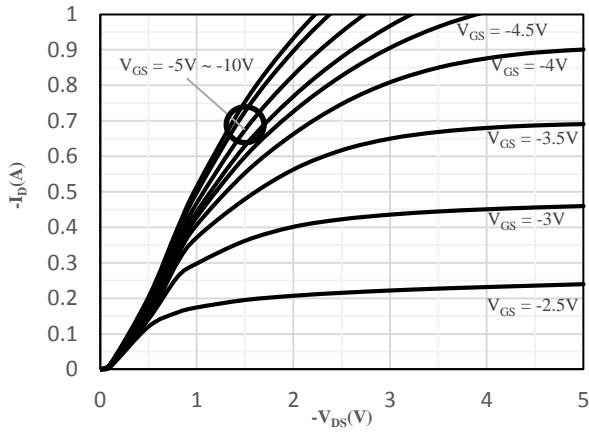


Fig 1 Typical Output Characteristics

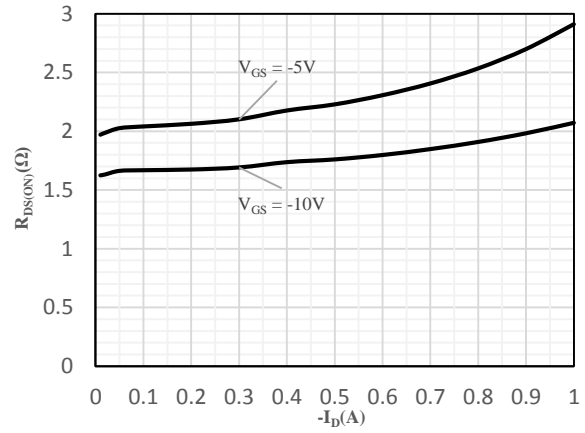


Fig 2 On-Resistance vs. Drain Current and Gate Voltage

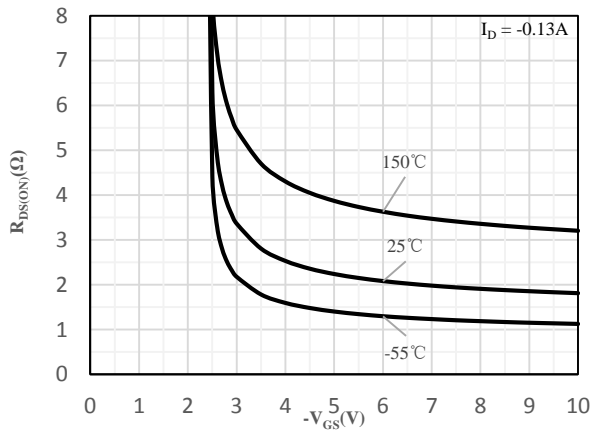


Fig 3 On-Resistance vs. Gate-Source Voltage

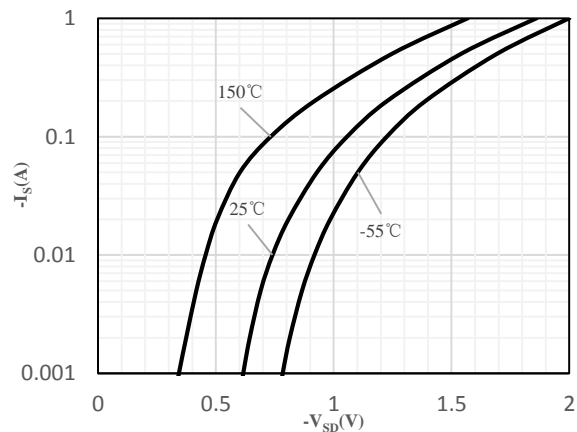


Fig 4 Body-Diode Characteristics

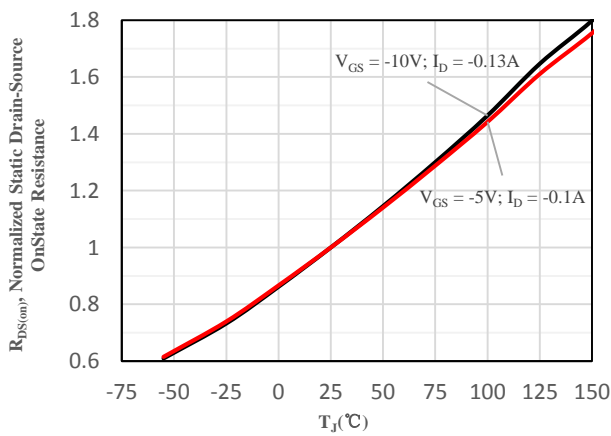


Fig 5 Normalized On-Resistance vs. Junction Temperature

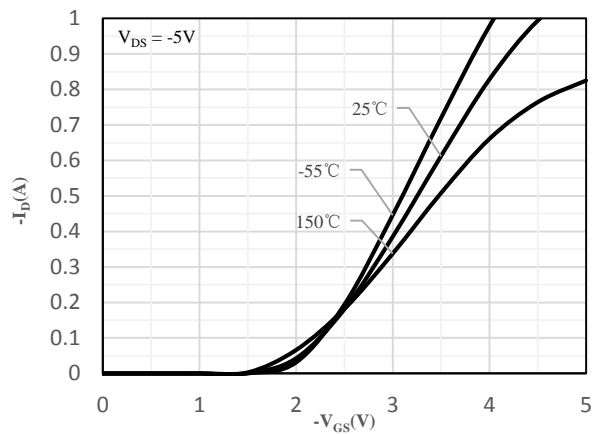


Fig 6 Transfer Characteristics

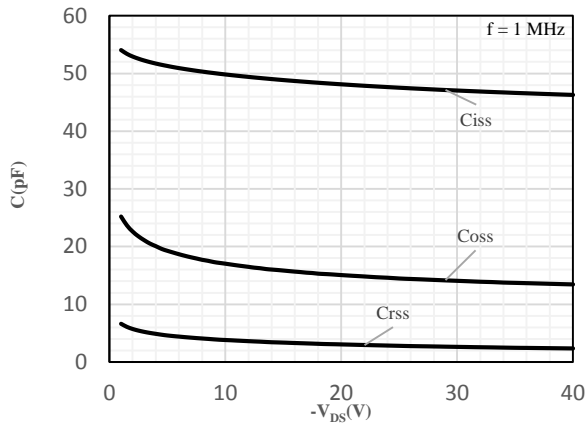


Fig 7 Capacitance Characteristics

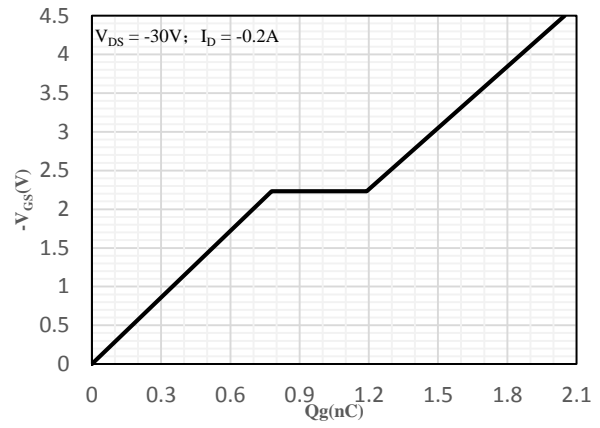


Fig 8 Gate-Charge Characteristics

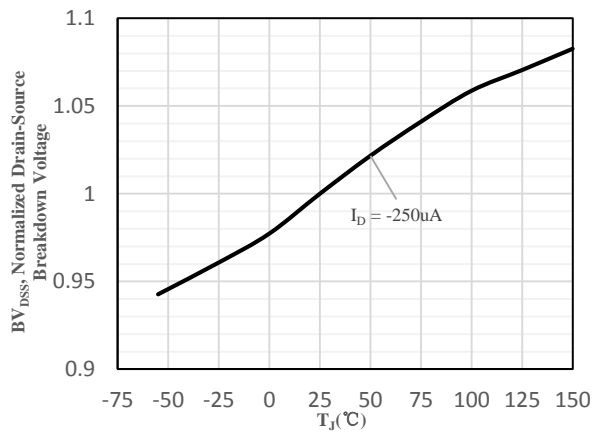


Fig 9 Normalized Breakdown Voltage vs. Junction Temperature

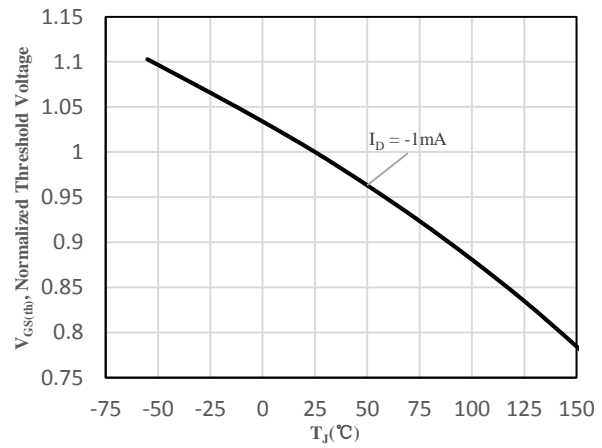
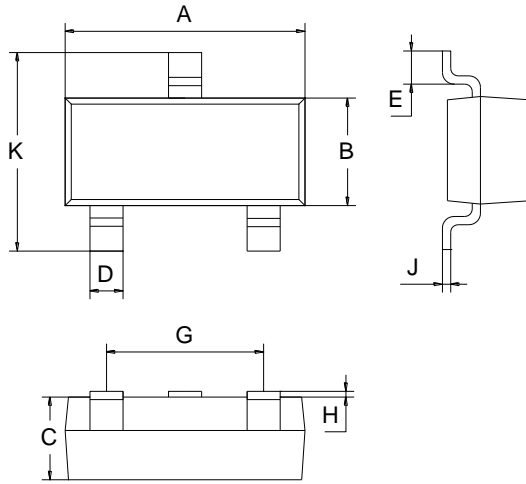


Fig 10 Normalized $V_{GS(th)}$ vs. Junction Temperature



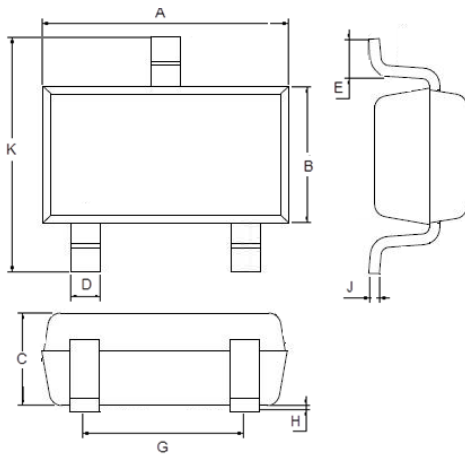
Package Outline Dimensions (Unit: mm)

SOT-23



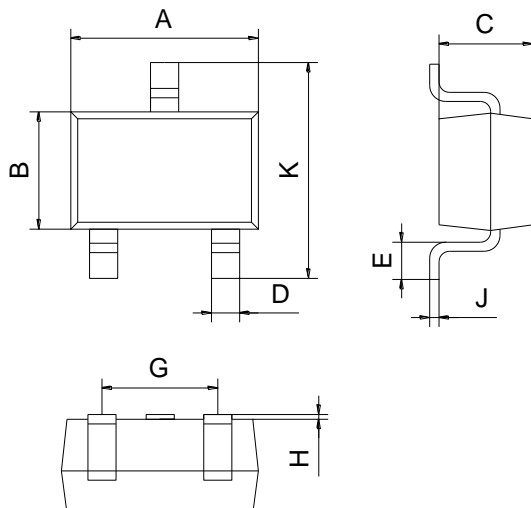
SOT-23		
Dimension	Min.	Max.
A	2.70	3.10
B	1.10	1.50
C	0.90	1.10
D	0.30	0.50
E	0.35	0.48
G	1.80	2.00
H	0.02	0.10
J	0.05	0.15
K	2.20	2.60

SOT-23-3L



SOT-23-3L		
Dimension	Min.	Max.
A	2.80	3.00
B	1.50	1.70
C	1.00	1.20
D	0.35	0.45
E	0.35	0.55
G	1.80	2.00
H	0.02	0.10
J	0.10	0.20
K	2.60	3.00

SOT-323

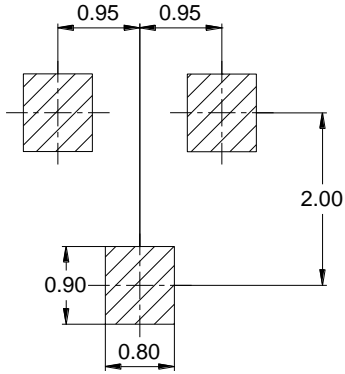


SOT-323		
Dimension	Min.	Max.
A	2.00	2.20
B	1.15	1.35
C	0.90	1.10
D	0.15	0.35
E	0.25	0.40
G	1.20	1.40
H	0.02	0.10
J	0.05	0.15
K	2.20	2.40

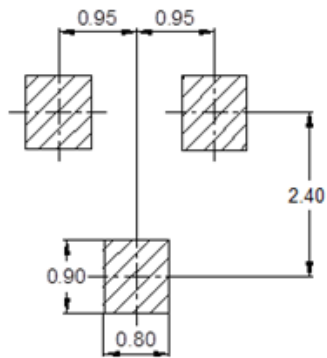


Mounting Pad Layout (Unit: mm)

SOT-23



SOT-23-3L



SOT-323

